

High practical impact (Being replaced by Hostaform® S 9364)

Celcon® acetal copolymer grade TX90Plus is a highly impact modified grade. Celcon® TX90Plus provides a significant improvement in impact strength and flexibility while retaining many of the other performance properties of acetal copolymer. Chemical abbreviation according to ISO 1043-1: POM-HI Celcon® TX90Plus is being replaced by Hostaform® S 9364.

Rheological properties

Melt mass-flow rate8Melt mass-flow rate, Temperature190Melt mass-flow rate, Load2.16	
Moulding shrinkage range, parallel2.1Moulding shrinkage range, normal2.0	,
Typical mechanical properties	
Yield stress, 50mm/min46Yield strain, 50mm/min14Flexural Modulus1650Flexural Stress at 3.5%46Tensile creep modulus, 1h1300Tensile creep modulus, 1000h700Charpy impact strength, 23°CNBCharpy impact strength, -30°C205Charpy notched impact strength, -30°C8Izod notched impact strength, 23°C10	MPa ISO 527-1/-2 MPa ISO 527-1/-2 % ISO 527-1/-2 MPa ISO 527-1/-2 MPa ISO 527-1/-2 MPa ISO 178 MPa ISO 178 MPa ISO 899-1 MPa ISO 899-1 kJ/m² ISO 179/1eU kJ/m² ISO 179/1eU kJ/m² ISO 179/1eA kJ/m² ISO 179/1eA kJ/m² ISO 180/1A kJ/m² ISO 180/1A
Thermal properties	
Melting temperature, 10 ° C/min166Temp. of deflection under load, 1.8 MPa76Vicat softening temperature, 50 ° C/h, 50N161Coeff. of linear therm. expansion, parallel120Coeff. of linear therm. expansion, normal140Thermal conductivity of melt0.16	°C ISO 75-1/-2
•	

Printed: 2023-09-15



Page: 1 of 11





Injection

Drying Temperature	100 - 120 °C
Drying Time, Dehumidified Dryer	3-4 h
Max. mould temperature	80 - 120 °C
Back pressure	2 MPa
Injection speed	slow
Ejection temperature	140 °C

Internal

Characteristics

Injection molding

Additional information

Additives

Release agent

Standard reciprocating screw injection molding machines with a high compression screw (minimum 3:1 and preferably 4:1) and low back pressure (0.35 Mpa/50 PSI) are favored. Using a low compression screw (I.E. general purpose 2:1 compression ratio) can result in unmelted particles and poor melt homogeneity. Using a high back pressure to make up for a low compression ratio may lead to excessive shear heating and deterioration of the material.

Melt Temperature: Preferred range 182-199 C (360-390 F). Melt temperature should never exceed 230 C (450 F).

Mold Surface Temperature: Preferred range 82-93 C (180-200 F) especially with wall thickness less than 1.5 mm (0.060 in.). May require mold temperature as high as 120 C (250 F) to reproduce mold surface or to assure minimal molded in stress. Wall thickness greater than 3mm (1/8 in.) may use a cooler (65 C/150 F) mold surface temperature and wall thickness over 6mm (1/4 in.) may use a cold mold surface down to 25 C (80 F). In general, mold surface temperatures lower than 82 C (180 F) may hinder weld line formation and produce a hazy surface or a surface with flow lines, pits and other included defects that can hinder part performance.

Standard extruders with a length to diameter ratio of at least 20:1 are recommended. The screw should be a high compression ratio of at least 3:1 and preferably 4:1 to assure good melting and melt homogeneity. The design should be approximately 35% each for feed and metering sections with the remaining 30% as the transition zone.

Melt temperature: 160-220 C (320-430 F)

Standard extruders with a length to diameter ratio of at least 20:1 are recommended. The screw should be a high compression ratio of at least 3:1 and preferably 4:1 to assure good melting and uniform melt homogeneity. The design should be approximately 35% each for the feed and metering sections with the

Printed: 2023-09-15

Other extrusion

Film extrusion



Page: 2 of 11





remaining 30% as transition zone.

Melt temperature 180-220 C (355-430F)

Sheet extrusion

Standard extruders with a length to diameter ratio of at least 20:1 are recommended. The screw should be a high compression ratio (at least 3:1 and preferably 4:1) to assure good melting and uniform melt homogeneity. The screw design should be approximately 35% each for the feed and metering sections with the remaining 30% as the transition zone.

Melt temperature 180-190 C (355-375 F).

Printed: 2023-09-15

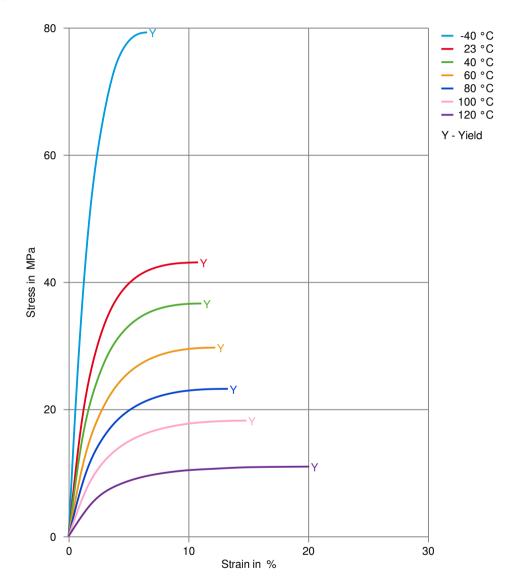


Page: 3 of 11





Stress-strain



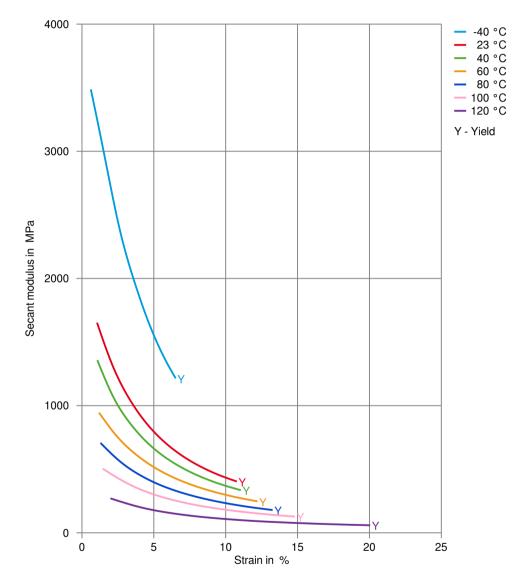


Page: 4 of 11





Secant modulus-strain



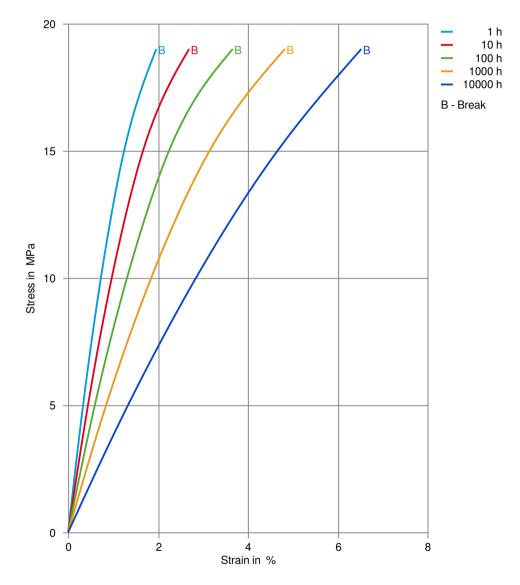


Page: 5 of 11





Stress-strain (isochronous) 23°C



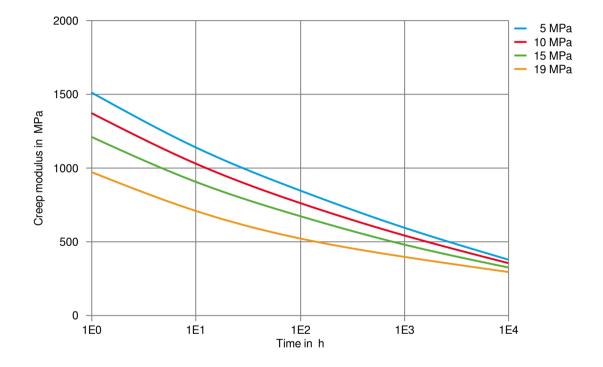


Page: 6 of 11





Creep modulus-time 23°C



Printed: 2023-09-15

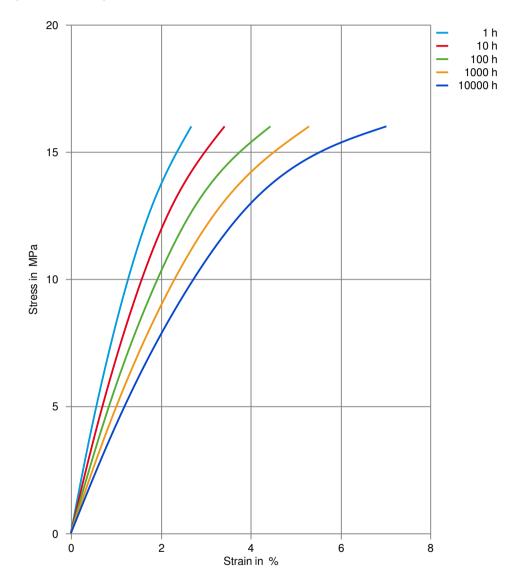


Page: 7 of 11





Stress-strain (isochronous) 40°C



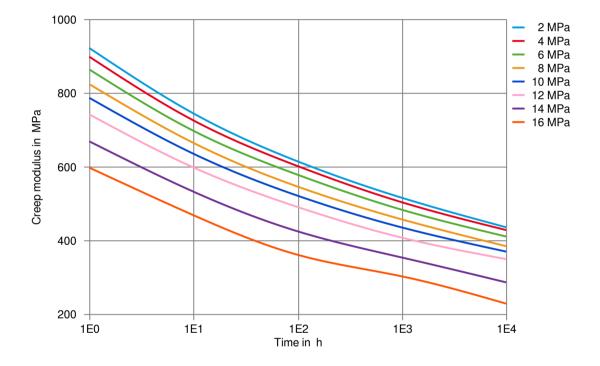


Page: 8 of 11





Creep modulus-time 40°C



Printed: 2023-09-15



Page: 9 of 11





Processing Texts	
Pre-drying	Drying typically not required. If material has come in contact with moisture through improper storage or handling or through regrind use, drying may be necessary to prevent splay and odor problems.
Injection molding	Standard reciprocating screw injection molding machines with a high compression screw (minimum 3:1 and preferably 4:1) and low back pressure (0.35 Mpa/50 PSI) are favored. Using a low compression screw (I.E. general purpose 2:1 compression ratio) can result in unmelted particles and poor melt homogeneity. Using a high back pressure to make up for a low compression ratio may lead to excessive shear heating and deterioration of the material.
	Melt Temperature: Preferred range 182-199 C (360-390 F). Melt temperature should never exceed 230 C (450 F).
	Mold Surface Temperature: Preferred range 82-93 C (180-200 F) especially with wall thickness less than 1.5 mm (0.060 in.). May require mold temperature as high as 120 C (250 F) to reproduce mold surface or to assure minimal molded in stress. Wall thickness greater than 3mm (1/8 in.) may use a cooler (65 C/150 F) mold surface temperature and wall thickness over 6mm (1/4 in.) may use a cold mold surface down to 25 C (80 F). In general, mold surface temperatures lower than 82 C (180 F) may hinder weld line formation and produce a hazy surface or a surface with flow lines, pits and other included defects that can hinder part performance.
Injection molding Preprocessing	Drying is generally not required because Celcon® and Hostaform® acetal copolymers are not hydroscopic nor are they degraded by moisture during processing. Excessive moisture can lead to splay (silver streaking) in molded parts. For better uniformity in molding especially when using regrind or material that has been stored in containers open to the atmosphere, recommended drying conditions are 80 C (180 F) for 3hours. Desiccant hopper dryers are not required. Maximum water content = 0.35%
Injection molding Postprocessing	Postprocessing conditioning and moisturizing are not required. It may be necessary to fixture large or complicated parts with varying wall thickness to prevent warpage while cooling to ambient temperature.

Printed: 2023-09-15



Page: 10 of 11

